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Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)
100	5	0.66	3.5

Features and Benefits

- Low Forward Voltage Drop
- Excellent High Temperature Stability
- Soft, Fast Switching Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Description and Applications

Packaged in the compact thermally efficient PowerDI5 package, the SDT5H100LP5 provides very low V_F and excellent reverse leakage stability at high temperatures. It is ideal for use as a rectifier, freewheel diode or blocking diode in:

- DC-DC Converters
- AC-DC Adaptors

Mechanical Data

- Case: PowerDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.093 grams (Approximate)

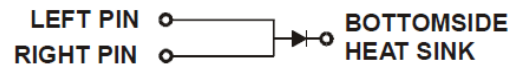
PowerDI5



Top View



Bottom View

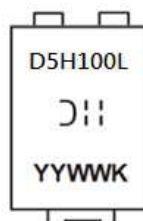


Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

Part Number	Case	Packaging
SDT5H100LP5-7	PowerDI5	1,500/Tape & Reel
SDT5H100LP5-7D (Note 5)	PowerDI5	1,500/Tape & Reel
SDT5H100LP5-13	PowerDI5	5,000/Tape & Reel
SDT5H100LP5-13D (Note 5)	PowerDI5	5,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
 5. PowerDI5 available in 5K quantity on 13-inch reel & 12mm tape, part number suffix "13D"; Diodes also provides 12mm tape with 7-inch reel, part number suffix "7D".

Marking Information


DII = Manufacturers' Marking
 D5H100L = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 16 = 2016)
 WW = Week Code (01 to 53)
 K = Factory Designator

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM}	100	V
Average Rectified Output Current	I _O	5	A
Non-Repetitive Peak Forward Surge Current 8.3ms	I _{FSM}	150	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	88	°C/W
Typical Thermal Resistance Junction to Ambient (Note 7)	R _{θJA}	18	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.55	—	V	I _F = 3A, T _J = +25°C
		—	0.48	—		I _F = 3A, T _J = +125°C
		—	—	0.66		I _F = 5A, T _J = +25°C
		—	—	0.61		I _F = 5A, T _J = +125°C
Leakage Current (Note 8)	I _R	—	—	3.5	μA	V _R = 100V, T _J = +25°C
		—	—	4.5	mA	V _R = 100V, T _J = +125°C

Notes: 6. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
7. Aluminum 2inch*2inch substrate PCB with 50mm x 50mm x 23mm Al heatsink.
8. Short duration pulse test used to minimize self-heating effect.

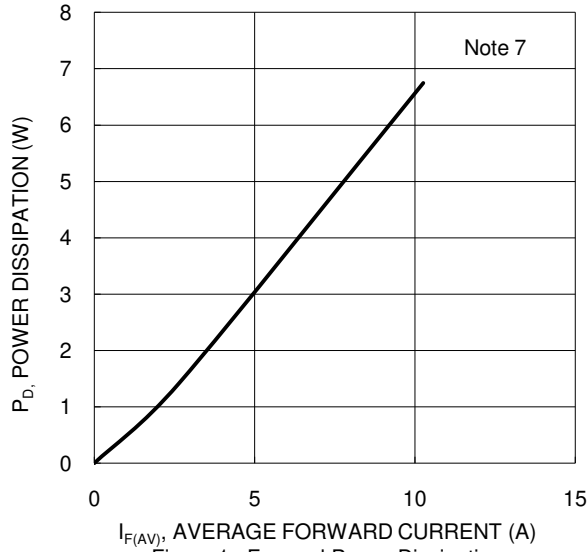


Figure 1. Forward Power Dissipation

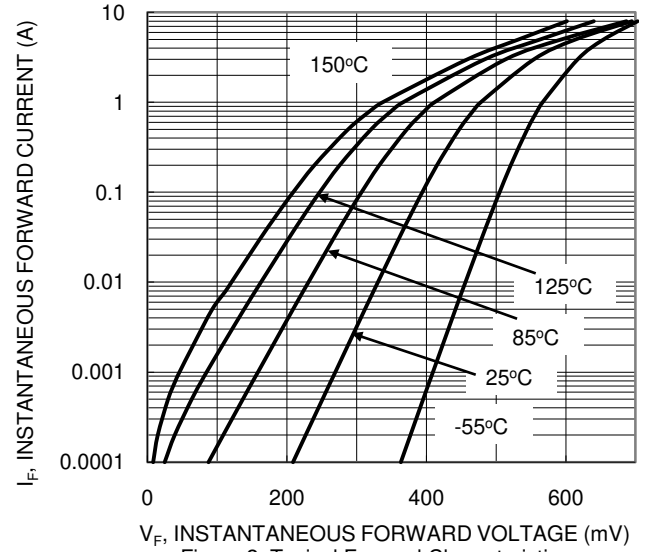


Figure 2. Typical Forward Characteristics

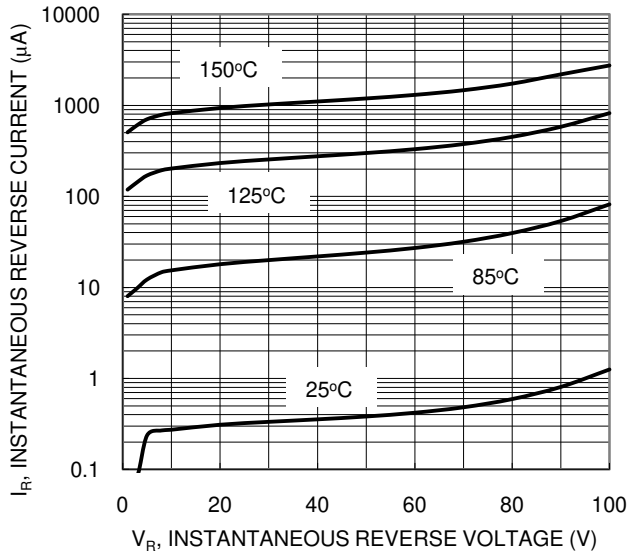


Figure 3. Typical Reverse Characteristics

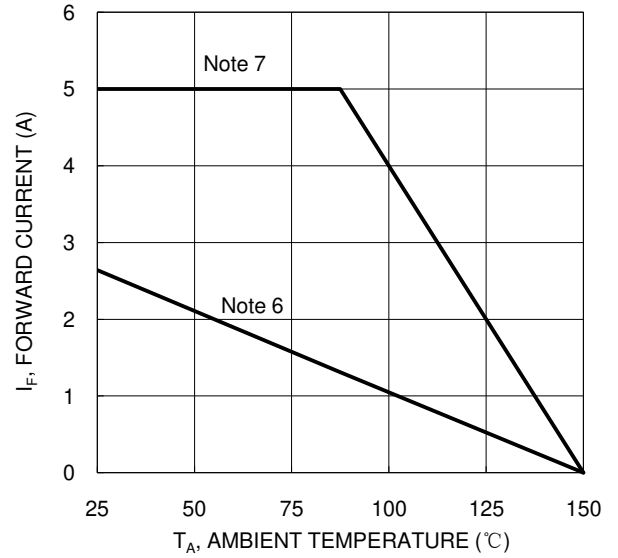


Figure 4. Forward Current Derating Curve

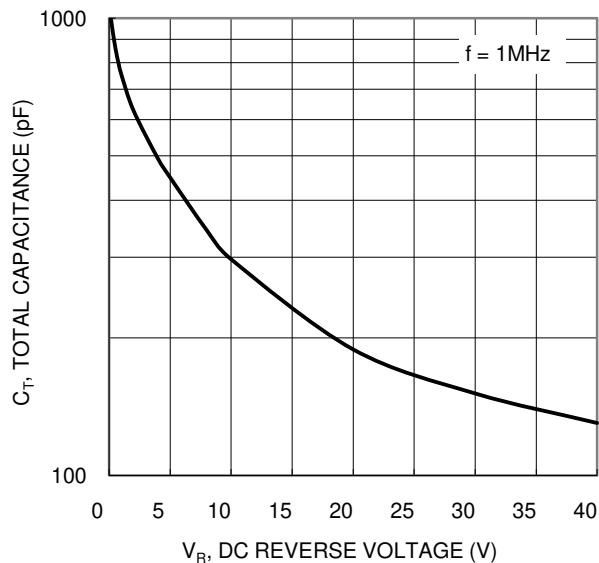
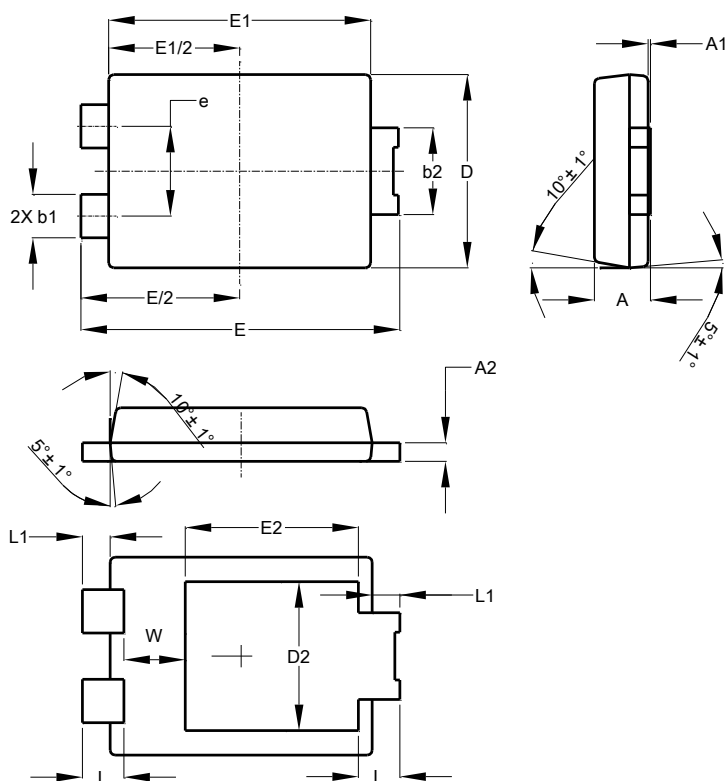


Figure 5. Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5

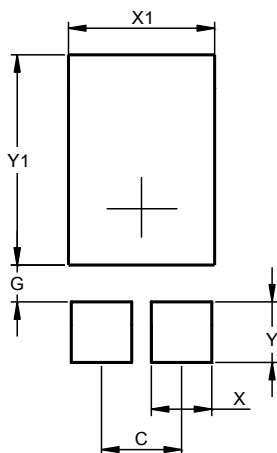


PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.504
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860

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